## NCN2612

## 6-Differential Channel 1:2 Switch for PCle 2.0 and Display Port 1.1

The NCN2612 is a 6-Channel differential SPDT switch designed to route PCI Express Gen2 and/or DisplayPort 1.1a signals. Due to the ultra-low ON-state capacitance ( 4.1 pF typ) and resistance (7 $\Omega$ typ), these switches have a signal bit rate (BR) of 5 Gbps , ideal for high frequency data signals. This switch pinout is designed to be used in ATX form factor desktop PCs and is available in a space-saving WQFN package. The NCN2612 uses $80 \%$ less quiescent power than other comprable PCIe switches.

## Features

- V ${ }_{\text {DD }}$ Power Supply from 3 V to 3.6 V
- Low Supply Current $250 \mu \mathrm{~A}$ typ
- 6 Differential Channels 2:1 MUX/DEMUX
- Compatible with Display Port 1.1a \& PCIe 2.0
- Data Rate: Supports 5 Gbps
- Low Ron Resistance: $7 \Omega$ typ
- Low Con Capacitance: 4.1 pF
- Space Saving Small WQFN-56 Package
- This is a $\mathrm{Pb}-F r e e$ Device


## Typical Applications

- Notebook Computers
- Desktop Computers
- Server/Storage Networks

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MARKING
DIAGRAM

## ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| NCN2612MTTWG | WQFN56 <br> (Pb-Free) | $2000 /$ <br> Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NCN2612


Figure 1. NCN2612 Block Diagram

TRUTH TABLE (SEL Control)

| Function | SEL |
| :--- | :---: |
| PCI_Express Gen2 Path is Active (Tx, Rx) | L |
| Digital Video Port is Active (Dx, HPDx, AUX) | H |

TRUTH TABLE (Latch Control)

| LE | Internal Mux Select |
| :---: | :--- |
| 0 | Respond to Changes on SEL |
| 1 | Latched |

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Figure 2. Pinout (Top View)

PIN FUNCTION AND DESCRIPTION

| Pin | Name | Description |
| :---: | :---: | :---: |
| $\begin{gathered} 6,17,22,27, \\ 34,50,55 \end{gathered}$ | VDD | DC Supply, $3.3 \mathrm{~V} \pm 10 \%$ |
| $\begin{gathered} 1,11,16,20,21, \\ 28,29,35,48, \\ 49,56 \end{gathered}$ | GND | Power Ground. |
| Exposed Pad | - | The exposed pad on the backside of package is internally connected to Gnd. Externally the exposed pad should also be user-connected to GND. |
| 2 | IN_0+ | Differential input from GMCH PCIE outputs. IN_0+ makes a differential pair with IN_0-. |
| 3 | IN_0- | Differential input from GMCH PCIE outputs. IN_0- makes a differential pair with IN_0+. |
| 4 | IN_1+ | Differential input from GMCH PCIE outputs. IN_1+ makes a differential pair with IN_1-. |
| 5 | IN_1- | Differential input from GMCH PCIE outputs. IN_1- makes a differential pair with IN_1+. |
| 7 | IN_2+ | Differential input from GMCH PCIE outputs. IN_2+ makes a differential pair with IN_2-. |
| 8 | IN_2- | Differential input from GMCH PCIE outputs. IN_2- makes a differential pair with IN_2+. |
| 9 | IN_3+ | Differential input from GMCH PCIE outputs. IN_3+ makes a differential pair with IN_3-. |
| 10 | IN_3- | Differential input from GMCH PCIE outputs. IN_3- makes a differential pair with IN_3+. |
| 12 | OUT+ | Pass-through output from AUX+ input when SEL = 1. Pass-through output from Rx0+ input when SEL $=0$. |
| 13 | OUT- | Pass-through output from AUX- input when SEL = 1. Pass-through output from Rx0-input when SEL $=0$. |
| 14 | X+ | $\mathrm{X}+$ is an analog pass-through output corresponding to Rx1+. |
| 15 | X- | X - is an analog pass-through output corresponding to the Rx 1 - input. The path from $\mathrm{R} \times 1$ - to X - must be matched with the path from $\mathrm{R} \times 1+$ to $\mathrm{X}+\mathrm{X}+$ and X - form a differential pair when the pass-through mux mode is selected. |
| 18 | SEL | SEL controls the mux through a flow-through latch. SEL = 0 for PCIE Mode; SEL = 1 for DP Mode |
| 19 | LE | The latch gate is controlled by LE. |
| 43, 42 | D0+, D0- | Analog pass-through output\#1 corresponding to IN_0+ and IN_0-, when SEL = 1 . |
| 41, 40 | D1+, D1- | Analog pass-through output\#1 corresponding to IN_1+ and IN_1-, when SEL = 1 . |
| 39, 38 | D2+, D2- | Analog pass-through output\#1 corresponding to IN_2+ and IN_2-, when SEL = 1 . |
| 37, 36 | D3+, D3- | Analog pass-through output\#1 corresponding to IN_3+ and IN_3-, when SEL = 1 . |
| 54, 53 | Tx0+, Tx0- | Analog pass-through output\#2 corresponding to IN_0+ and IN_0- when SEL $=0$. |
| 52, 51 | Tx1+, Tx1- | Analog pass-through output\#2 corresponding to IN_1+ and IN_1- when SEL = 0. |
| 47, 46 | Tx2+, Tx2- | Analog pass-through output\#2 corresponding to IN_2+ and IN_2- when SEL $=0$. |
| 45, 44 | Tx3+, Tx3- | Analog pass-through output\#2 corresponding to IN_3+ and IN_3- when SEL $=0$. |
| 26 | AUX+ | Differential input from HDMI/DP connector. AUX+ makes a differential pair with AUX-. AUX+ is passed through to the OUT+ pin when SEL $=1$. |
| 25 | AUX- | Differential input from HDMI/DP connector. AUX- makes a differential pair with AUX+. AUX- is passed through to the OUT- pin when SEL $=1$. |
| 24 | HPD1 | Positive low frequency HPD input handshake protocol signal. |
| 23 | HPD2 | Negative low frequency HPD input handshake protocol signal (normally not connected). |
| 33 | R×0+ | Differential input from PCIE connector or device. R×0+ makes a differential pair with R×0-. R×0+ is passed through to the OUT+ pin when SEL $=0$. |
| 32 | Rx0- | Differential input from PCIE connector or device. RxO - makes a differential pair with $\mathrm{R} \times 0+$. $\mathrm{R} \times 0$ - is passed through to the OUT- pin when SEL $=0$. |
| 31 | Rx1+ | Differential input from PCIE connector or device. Rx1+ makes a differential pair with R×1-. R×1+ is passed through to the $\mathrm{X}+$ pin when $\mathrm{SEL}=0$. |
| 30 | Rx1- | Differential input from PCIE connector or device. $\mathrm{R} \times 1$ - makes a differential pair with $\mathrm{R} \times 1+$. $\mathrm{R} \times 1$ - is passed through to the $\mathrm{X}-$ pin on the path that matches the $\mathrm{Rx} 1+$ to $\mathrm{X}+$ pin. |

MAXIMUM RATINGS

| Parameter | Symbol | Rating | Unit |
| :--- | :---: | :---: | :---: |
| Power Supply Voltages | $\mathrm{V}_{\mathrm{DD}}$ | $-0.5 \leq \mathrm{V}_{\mathrm{DD}} \leq 5.3$ | V |
| Input/Output Voltage Range of the Switch | $\mathrm{V}_{\mathrm{I}} \& \mathrm{~V}_{\mathrm{O}}$ | $-0.7 \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Selection Pin Voltages | $\mathrm{V}_{\mathrm{SEL}}$ | $-0.5 \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{DD}}+0.3$ | V |
| Continuous Current Through One Switch Channel | $\mathrm{I}_{\mathrm{IO}}$ | $\pm 120$ | mA |
| Maximum Junction Temperature (Note 1) | $\mathrm{T}_{\mathrm{J}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Ambient Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Thermal Resistance, Junction-to-Air (Note 2) | $\mathrm{R}_{\text {日JA }}$ | 37 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Power dissipation must be considered to ensure maximum junction temperature $\left(T_{J}\right)$ is not exceeded.
2. This parameter is based on EIA/JEDEC $51-7$ with a 4-layer PCB, $80 \mathrm{~mm} \times 80 \mathrm{~mm}$, two $10 z \mathrm{Cu}$ material internal planes and top planes of 2oz Cu material.

ELECTRICAL CHARACTERISTICS $\left(V_{D D}=+3.3 \mathrm{~V} \pm 10 \%, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $+85^{\circ} \mathrm{C}$ and $\mathrm{T}_{\mathrm{J}}$ up to $125^{\circ} \mathrm{C}$, unless otherwise noted. All Typical values are at $\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted)

| Symbol | Characteristics | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY |  |  |  |  |  |  |
| $V_{D D}$ | Supply Voltage Range |  | 3.0 | 3.3 | 3.6 | V |
| IDD | Power Supply Current | $\mathrm{V}_{\mathrm{DD}}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=\mathrm{GND}$ or $\mathrm{V}_{\mathrm{DD}}$ |  | 250 | 500 | $\mu \mathrm{A}$ |

DATA SWITCH PERFORMANCE (for both PCle and Display Port applications, unless otherwise noted)

| $\mathrm{V}_{\text {IN }}$ | Data Input/Output Voltage Range |  | -0.1 |  | $\mathrm{V}_{\mathrm{DD}}$ | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| R ${ }_{\text {ON }}$ | On Resistance (Tx, Rx) | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{IN}}=40 \mathrm{~mA}$ |  | 7 | 13 | $\Omega$ |
| Ron | On Resistance (Dx,HPDx,AUX) | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{IN}}=40 \mathrm{~mA}$ |  | 7.5 | 13 | $\Omega$ |
| $\mathrm{R}_{\text {ON(flat) }}$ | On Resistance Flatness | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}, 0 \mathrm{~V} \leq \mathrm{VIN} \leq \mathrm{V}_{\mathrm{DD}}, \mathrm{I}_{\mathrm{IN}}=40 \mathrm{~mA}$ |  | 0.1 | 1.24 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | On Resistance Matching (Tx, Rx) | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{IN}}=40 \mathrm{~mA}$ |  |  | 0.35 | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON }}$ | On Resistance Matching (Dx,HPDx,AUX) | $\mathrm{V}_{\mathrm{DD}}=3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{IN}}=40 \mathrm{~mA}$ |  |  | 0.35 | $\Omega$ |
| Con | On Capacitance | $\mathrm{f}=1 \mathrm{MHz}$, Switch On, Open Output |  | 4.1 |  | pF |
| CofF | Off Capacitance | $\mathrm{f}=1 \mathrm{MHz}$, Switch Off |  | 2.6 |  | pF |
| Ion | $\begin{aligned} & \text { On Leakage Current (IN_/ } \\ & \text { X_/OUT_) } \end{aligned}$ | $\mathrm{V}_{\mathrm{DD}}=+3.6 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=\mathrm{VX}_{-}=\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$, $+1.2 \mathrm{~V} ; \mathrm{V}_{\mathrm{D}}$ or $\mathrm{V}_{\mathrm{TX}}$ or $\bar{V}_{\text {HPD }}$ or $V_{\mathrm{RX}}$ or $V_{\text {AUX_ }}=$ ūnconnected | -1 |  | +1 | $\mu \mathrm{A}$ |
| IOFF | Off Leakage Current (D/ TX_/ HPD_/RX_/AUX) | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=+3.6 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{X}}=\mathrm{V}_{\mathrm{OUT}}=0 \mathrm{~V}, \\ & +1.2 \mathrm{~V} ; \mathrm{V}_{\mathrm{D}_{-}} \text {or } \mathrm{V}_{\mathrm{TX}}, \mathrm{~V}_{\mathrm{HPD}} / \mathrm{AUX}_{-} \text {or } \mathrm{V}_{\mathrm{RX}}= \\ & 1.2 \mathrm{~V}, 0 \mathrm{~V} \end{aligned}$ | -1 |  | +1 | $\mu \mathrm{A}$ |

CONTROL LOGIC CHARACTERISTICS (SEL and LE pins)

| $\mathrm{V}_{\mathrm{IL}}$ | Off voltage input |  | 0 |  | 0.8 | V |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IH}}$ | High voltage input |  | 2 |  | $\mathrm{~V}_{\mathrm{DD}}$ | V |
| $\mathrm{I}_{\mathrm{IN}}$ | Off voltage input | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}$ | -1 |  | +1 | $\mu \mathrm{~A}$ |
| $\mathrm{C}_{\mathrm{IN}}$ | High voltage input | $\mathrm{f}=1 \mathrm{MHz}$ |  | 1 |  | pF |

DYNAMIC CHARACTERISTICS

| BR | Signal Data Rate | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=100 \Omega$ differential | 5 | Gbps |
| :---: | :---: | :---: | :---: | :---: |
| ILoss | Differential Insertion Loss | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=2.7 \mathrm{GHz}$ | -4 | dB |
|  |  | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=5 \mathrm{GHz}$ | -7 |  |
|  |  | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=7.5 \mathrm{GHz}$ | -13 |  |
| VISO | Differential Off Isolation | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=100 \mathrm{MHz}$ | -41 | dB |
|  |  | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=1.35 \mathrm{GHz}$ | -19 |  |
|  |  | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=3 \mathrm{GHz}$ | -16 |  |
| $\mathrm{X}_{\text {talk }}$ | Differential Crosstalk | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=2.5 \mathrm{GHz}$ | -27 | dB |
|  |  | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=5 \mathrm{GHz}$ | -20 |  |
|  |  | $\mathrm{R}_{\mathrm{S}}=\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{~F}=7.5 \mathrm{GHz}$ | -10 |  |

SWITCHING CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$, unless otherwise specified)

| Symbol | Characteristics | Conditions | Min | Typ | Max | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {SK1 }}$ | Bit-to-bit skew within same <br> differential channel | $\mathrm{R}_{\mathrm{S}}=50 \Omega, \mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{C}_{\mathrm{L}}=4 \mathrm{pF}$ |  | 7 |  | ps |
| $\mathrm{T}_{\text {SK2 }}$ | Channel-to-channel skew | $\mathrm{R}_{\mathrm{S}}=50 \Omega, \mathrm{R}_{\mathrm{L}}=200 \Omega, \mathrm{C}_{\mathrm{L}}=4 \mathrm{pF}$ |  | 55 |  | ps |

SELECTION PINS SWITCHING CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{DD}}=+3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$, unless otherwise specified)

| Symbol | Characteristics | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TSELON | SEL to Switch turn ON time | VDX_A or VDX_B $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, VHPD_X or VAUX_X $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{LE}=\mathrm{V}_{\mathrm{DD}}, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pf}$ |  | 8 | 20 | ns |
| $\mathrm{T}_{\text {SELOFF }}$ | SEL to Switch turn OFF time | $\mathrm{VDX} A$ or $\mathrm{VDX} B=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, VHPD_X or VAUX_X $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{LE}=\mathrm{V}_{\mathrm{DD}}, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pf}$ |  | 5 | 10 | ns |
| $\mathrm{T}_{\text {SET }}$ | LE setup time SEL to LE | VDX_A or VDX_B $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, VHPD_X or VAUX_X $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{LE}=\mathrm{V}_{\mathrm{DD}}, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pf}$ |  | 1 |  | ns |
| THold | LE hold time LE to SEL | VDX_A or VDX_B $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, VHPD_X or VAUX_X $=+1.0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{LE}=\mathrm{V}_{\mathrm{DD}}, \mathrm{C}_{\mathrm{L}}=100 \mathrm{pf}$ |  | 1 |  | ns |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.


Figure 3. Differential Insertion Loss/Differential Return Loss


Differential Off Isolation $=20 \log \left(\frac{\mathrm{~V}_{\mathrm{OUT}+}-\mathrm{V}_{\mathrm{OUT}-}}{\mathrm{V}_{\mathrm{IN}+}-\mathrm{V}_{\mathrm{IN}-}}\right)$
Figure 4. Differential Off-Isolation


Figure 5. Differential Crosstalk

Measurements are standardized against shorts at IC terminals.
Differential OFF-Isolation is measured between IN_ and "OFF" D or TX, X and "OFF" HPD or RX1, OUT and "OFF" AUX or RX0 terminal on each switch under Figure 3.
Differential ON-Isolation is measured between IN_ and "ON" D or TX, X and "ON" HPD or RX1, OUT and "ON" AUX or RXO terminal on each switch under Figure 4.
Differential Crosstalk is measured between any two pairs.


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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | WQFN56 5x11, 0.5P | PAGE 1 OF 1 |

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